IPC ASSOCIATION ELECTRONIC	Material Com © Copyright 2005. SINDUSTRIES international and P	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under international and Pan-American copyright conventions.			nder both				ances within the manu lower level materials					
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				e *	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				ials and Mfg Information			
upplier	r Information													
Company name* Company unique ID				ique ID		Unique ID Authority			Respo	Response Date*				
nsemi											2024-05-20			
ontact N	ame	Title - Contact			P	Phone - Contact*				Email - Contact*				
?roduct-E	Env-Stewards		Product Enviro Compliance			1	NA			Prod	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - R				e - Representative			Phone - Representative*			Email	Email - Representative*			
Product-Env-Stewards Product Enviro Compliance					I	NA				Product-Env-Stewards@onsemi.com				
	Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Date	Version	Manufacturing Si	te	Weight*	UOM	Unit Type	
		KSD1616AGTA NPN/60V/14		NPN/60V/1A/200	V/1A/200-400		2024-05-20 CNF			219.0385	mg	Each		
	cturing Process Inform		Comminal Dago	Allow	-STD-020 MS	II Dating	Dook Droop	as Dody Town	erature Max Time at	Dook Tommo	notives Niverka	er of Reflow Cy	olog	
	3		Terminal Base Alloy J-STD CU Allov NA			L Kating	0	SS Body Temp	30	1 '	onds 3	er of Reflow Cy	cies	
omments	` ′		O Alloy	I	IA.			<u> </u>	30	sec	onus 3			
Jimments)													
	information regarding materia	.1	-1											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member states) of the part identified above. If a homogeneous material within the part contains a RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part general within the part contains a RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part general within the part applicable quantity limit identified above. If a homogeneous material within the part general within the part applicable quantity limit identified above. If a homogeneous material within the part general within the part applicable quantity limit identified above. If a homogeneous material within the part general within the part applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, such as the correct of th											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.075	mg	Supplier	Silicon (Si)	7440-21-3		0.075	mg
Die Attach	0.0375	mg	Supplier	Silver (Ag)	7440-22-4		0.0319	mg
	<u> </u>		Supplier	Phenolic Resin	Proprietary Data		0.0056	mg
Lead Frame	101.0		Supplier	Silver (Ag)	7440-22-4		0.0101	mg
			Supplier	Iron (Fe)	7439-89-6		0.101	mg
			Supplier	Copper (Cu)	7440-50-8		100.8586	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0303	mg
Mold Compound-Black	112.0			Phenol Resin	proprietary data		11.2	mg
			Supplier	Carbon Black (C)	1333-86-4		1.12	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		86.24	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		13.44	mg
Plating	5.85	mg	Supplier	Tin (Sn)	7440-31-5		5.85	mg
Wire Bond - Au	0.076	mg	Supplier	Gold (Au)	7440-57-5		0.076	mg